PS21961-ST

TRANSFER-MOLD TYPE
INSULATED TYPE

PS21961-ST



INTEGRATED POWER FUNCTIONS

600V/3A low-loss RC-IGBT inverter bridge with N-side three phase output DC-to-AC power conversion.
Open emitter type.

INTEGRATED DRIVE, PROTECTION AND SYSTEM CONTROL FUNCTIONS

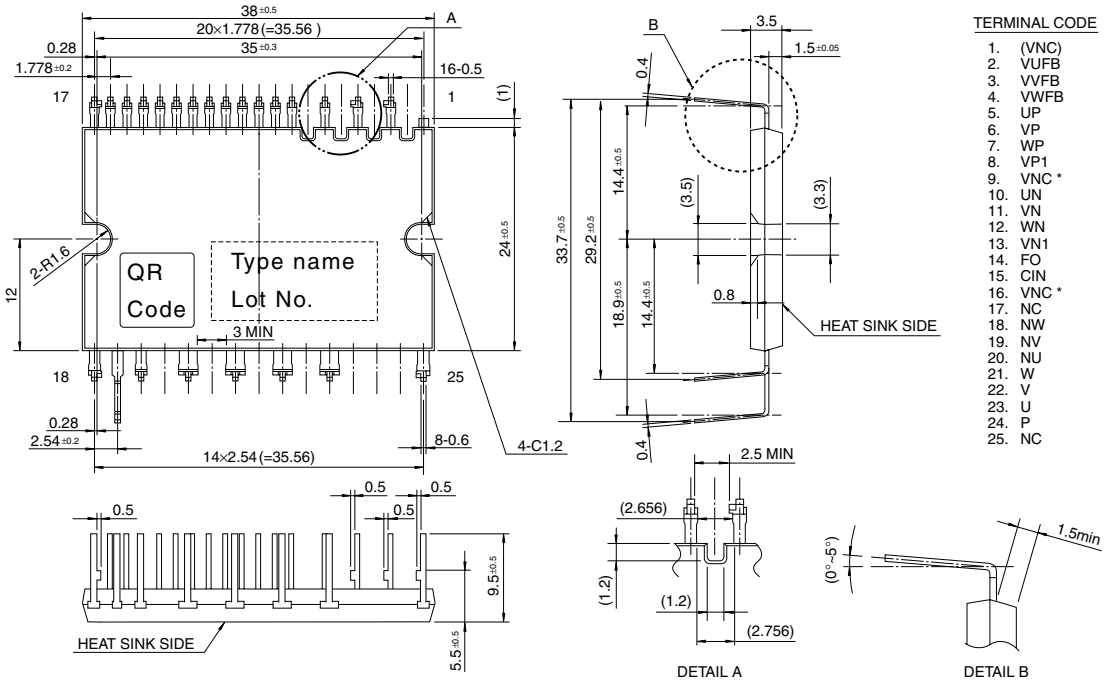
- For upper-leg IGBTs : Drive circuit, High voltage high-speed level shifting, Control supply under-voltage (UV) protection.
- For lower-leg IGBTs : Drive circuit, Control supply under-voltage protection (UV), Short circuit protection (SC), Over temperature protection (OT).
- Fault signaling : Corresponding to an SC fault (Lower-leg IGBT), a UV fault (Lower-side supply) or an OT fault (LVIC temperature).
- Input interface : 3V, 5V line (High Active).
- UL Approved : Yellow Card No. E80276

APPLICATION

AC100V~200V inverter drive for small power motor control.

Fig. 1 PACKAGE OUTLINES

Dimensions in mm



TERMINAL CODE

1. (VNC)
2. VUFB
3. VVFB
4. VWFB
5. UP
6. VP
7. WP
8. VP1
9. VNC *
10. UN
11. VN
12. WN
13. VN1
14. FO
15. CIN
16. VNC *
17. NC
18. NW
19. NV
20. NU
21. W
22. V
23. U
24. P
25. NC

*) Two VNC terminals (9 & 16 pin) are connected inside DIPIPM, please connect either one to the 15V power supply GND outside and leave another one open.

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MITSUBISHI ELECTRIC

MAXIMUM RATINGS (T_j = 25°C, unless otherwise noted)

INVERTER PART

Symbol	Parameter	Condition	Ratings	Unit
V_{CC}	Supply voltage	Applied between P-NU, NV, NW	450	V
$V_{CC(surge)}$	Supply voltage (surge)	Applied between P-NU, NV, NW	500	V
V_{CES}	Collector-emitter voltage		600	V
±I_C	Each IGBT collector current	T_C = 25°C	3	A
±I_{CP}	Each IGBT collector current (peak)	T_C = 25°C, less than 1ms	6	A
P_C	Collector dissipation	T_C = 25°C, per 1 chip	21.3	W
T_j	Junction temperature	(Note 1)	–20~+125	°C

Note 1 : The maximum junction temperature rating of the power chips integrated within the DIPIPM is 150°C (@ $T_C \leq$ 100°C). However, to ensure safe operation of the DIPIPM, the average junction temperature should be limited to $T_{j(ave)} \leq$ 125°C (@ $T_C \leq$ 100°C).

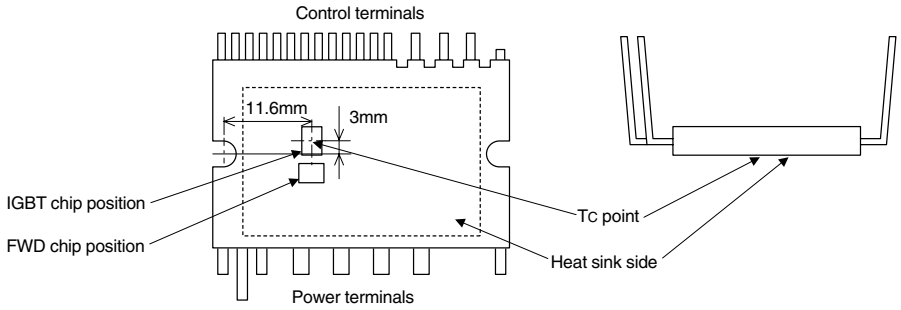
CONTROL (PROTECTION) PART

Symbol	Parameter	Condition	Ratings	Unit
V_D	Control supply voltage	Applied between V_{P1}-V_{NC}, V_{N1}-V_{NC}	20	V
V_{DB}	Control supply voltage	Applied between V_{UFB}-U, V_{VFB}-V, V_{WFB}-W	20	V
V_{IN}	Input voltage	Applied between U_P, V_P, W_P, U_N, V_N, W_N-V_{NC}	–0.5~V_D+0.5	V
V_{FO}	Fault output supply voltage	Applied between F_O-V_{NC}	–0.5~V_D+0.5	V
I_{FO}	Fault output current	Sink current at F_O terminal	1	mA
V_{SC}	Current sensing input voltage	Applied between CIN-V_{NC}	–0.5~V_D+0.5	V

TOTAL SYSTEM

Symbol	Parameter	Condition	Ratings	Unit
$V_{CC(PROT)}$	Self protection supply voltage limit (short circuit protection capability)	V_D = 13.5~16.5V, Inverter part T_j = 125°C, non-repetitive, less than 2µs	400	V
T_C	Module case operation temperature	(Note 2)	–20~+100	°C
T_{stg}	Storage temperature		–40~+125	°C
V_{iso}	Isolation voltage	60Hz, Sinusoidal, 1 minute, Between pins and heat-sink plate	1500	V_{rms}

Note 2: T_C measurement point



THERMAL RESISTANCE

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
$R_{th(j-c)Q}$	Junction to case thermal resistance (Note 3)	Inverter RC-IGBT part (per 1/6 module)	—	—	4.7	°C/W

Note 3 : Grease with good thermal conductivity should be applied evenly with about +100μm~+200μm on the contacting surface of DIPIPM and heat-sink.
The contacting thermal resistance between DIPIPM case and heat sink ($R_{th(c-f)}$) is determined by the thickness and the thermal conductivity of the applied grease. For reference, $R_{th(c-f)}$ (per 1/6 module) is about 0.3°C/W when the grease thickness is 20μm and the thermal conductivity is 1.0W/m·k.

ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise noted)

INVERTER PART

Symbol	Parameter	Condition		Limits			Unit
				Min.	Typ.	Max.	
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_D = V_{DB} = 15V, V_{IN} = 5V	I_C = 3A, T_j = 25°C	—	1.70	2.20	V
			I_C = 3A, T_j = 125°C	—	1.80	2.30	
V_{EC}	FWD forward voltage	T_j = 25°C, –I_C = 3A, V_{IN} = 0V		—	1.50	2.00	V
t_{on}	Switching times	V_{CC} = 300V, V_D = V_{DB} = 15V, I_C = 3A, T_j = 125°C, V_{IN} = 0 ↔ 5V, Inductive load (upper-lower arm)		0.50	0.95	1.50	μs
t_{rr}				—	0.30	—	μs
$t_{c(on)}$				—	0.35	0.60	μs
t_{off}				—	1.40	2.00	μs
$t_{c(off)}$				—	0.50	0.80	μs
I_{CES}	Collector-emitter cut-off current	V_{CE} = V_{CES}	T_j = 25°C	—	—	1	mA
			T_j = 125°C	—	—	10	

CONTROL (PROTECTION) PART

Symbol	Parameter	Condition		Limits			Unit
				Min.	Typ.	Max.	
I_D	Circuit current	V_D = V_{DB} = 15V, V_{IN} = 5V	Total of V_{P1}-V_{NC}, V_{N1}-V_{NC}	—	—	2.80	mA
			V_{UFB}-U, V_{VFB}-V, V_{WFB}-W	—	—	0.55	
		V_D = V_{DB} = 15V, V_{IN} = 0V	Total of V_{P1}-V_{NC}, V_{N1}-V_{NC}	—	—	2.80	
			V_{UFB}-U, V_{VFB}-V, V_{WFB}-W	—	—	0.55	
V_{FOH}	Fault output voltage	V_{SC} = 0V, FO terminal pull-up to 5V by 10kΩ		4.9	—	—	V
V_{FOL}		V_{SC} = 1V, I_{FO} = 1mA		—	—	0.95	V
$V_{SC(ref)}$	Short circuit trip level	T_j = 25°C, V_D = 15V (Note 4)		0.43	0.48	0.53	V
I_{IN}	Input current	V_{IN} = 5V		0.70	1.00	1.50	mA
OT_t	Over temperature protection (Note 5)	V_D = 15V, At temperature of LVIC	Trip level	100	120	140	°C
OT_{rh}			Trip/reset hysteresis	—	10	—	
UV_{DBt}	Control supply under-voltage protection	T_j ≤ 125°C	Trip level	10.0	—	12.0	V
UV_{DBr}			Reset level	10.5	—	12.5	V
UV_{Dt}			Trip level	10.3	—	12.5	V
UV_{Dr}			Reset level	10.8	—	13.0	V
t_{FO}	Fault output pulse width	(Note 6)		20	—	—	μs
$V_{th(on)}$	ON threshold voltage	Applied between U_P, V_P, W_P, U_N, V_N, W_N-V_{NC}		—	2.1	2.6	V
$V_{th(off)}$	OFF threshold voltage			0.8	1.3	—	V
$V_{th(hys)}$	ON/OFF threshold hysteresis voltage			0.35	0.65	—	V

Note 4 : Short circuit protection is functioning only for the lower-arms. Please select the external shunt resistance such that the SC trip-level is less than 1.7 times of the current rating.

5 : Over temperature protection (OT) outputs fault signal, when the LVIC temperature exceeds OT trip temperature level (OT_t). In that case if the heat sink comes off DIPIPM or fixed loosely, don't reuse that DIPIPM. (There is a possibility that junction temperature of power chips exceeded maximum T_j (150°C)).

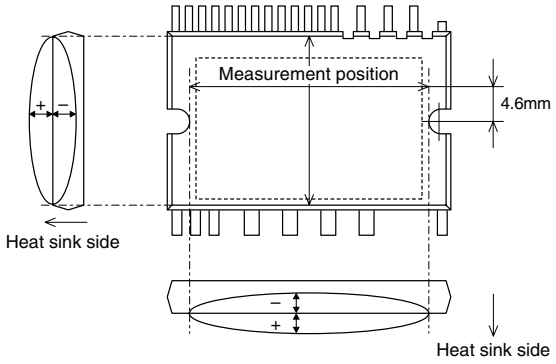
6 : Fault signal is asserted only corresponding to a SC, a UV or an OT failure at lower side, and the FO pulse width is different for each failure modes. For SC failure, FO output is with a fixed width of 20μsec(min), but for UV or OT failure, FO output continuously during the whole UV or OT period, however, the minimum FO pulse width is 20μsec(min) for very short UV or OT period less than 20μsec.

MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Condition		Limits			Unit
			Min.	Typ.	Max.	
Mounting torque	Mounting screw : M3 (Note 7)	Recommended : 0.69 N·m	0.59	—	0.78	N·m
Weight			—	10	—	g
Heat-sink flatness		(Note 8)	–50	—	100	μm

Note 7 : Plain washers (ISO 7089~7094) are recommended.

Note 8 : Flatness measurement position



RECOMMENDED OPERATION CONDITIONS

Symbol	Parameter	Condition		Limits			Unit
				Min.	Typ.	Max.	
V_{CC}	Supply voltage	Applied between P-NU, NV, NW		0	300	400	V
V_D	Control supply voltage	Applied between V_{P1}-V_{NC}, V_{N1}-V_{NC}		13.5	15.0	16.5	V
V_{DB}	Control supply voltage	Applied between V_{UFB}-U, V_{VFB}-V, V_{WFB}-W		13.0	15.0	18.5	V
ΔV_D, ΔV_{DB}	Control supply variation			–1	—	1	V/μs
t_{dead}	Arm shoot-through blocking time	For each input signal, $T_C \leq 100°C$		1.5	—	—	μs
f_{PWM}	PWM input frequency	$T_C \leq 100°C$, $T_j \leq 125°C$		—	—	20	kHz
I_O	Allowable r.m.s. current	V_{CC} = 300V, V_D = V_{DB} = 15V, P.F = 0.8, sinusoidal PWM, $T_j \leq 125°C$, $T_C \leq 100°C$ (Note 9)	f_{PWM} = 5kHz	—	—	2.0	Arms
			f_{PWM} = 15kHz	—	—	1.5	
PWIN(on)	Allowable minimum input pulse width	(Note 10)		0.5	—	—	μs
PWIN(off)				0.5	—	—	
V_{NC}	V_{NC} variation	Between V_{NC}-NU, NV, NW (including surge)		–5.0	—	5.0	V

Note 9 : The allowable r.m.s. current value depends on the actual application conditions.
10 : IPM might not make response if the input signal pulse width is less than the recommended minimum value.

Fig. 2 THE DIPIPM INTERNAL CIRCUIT

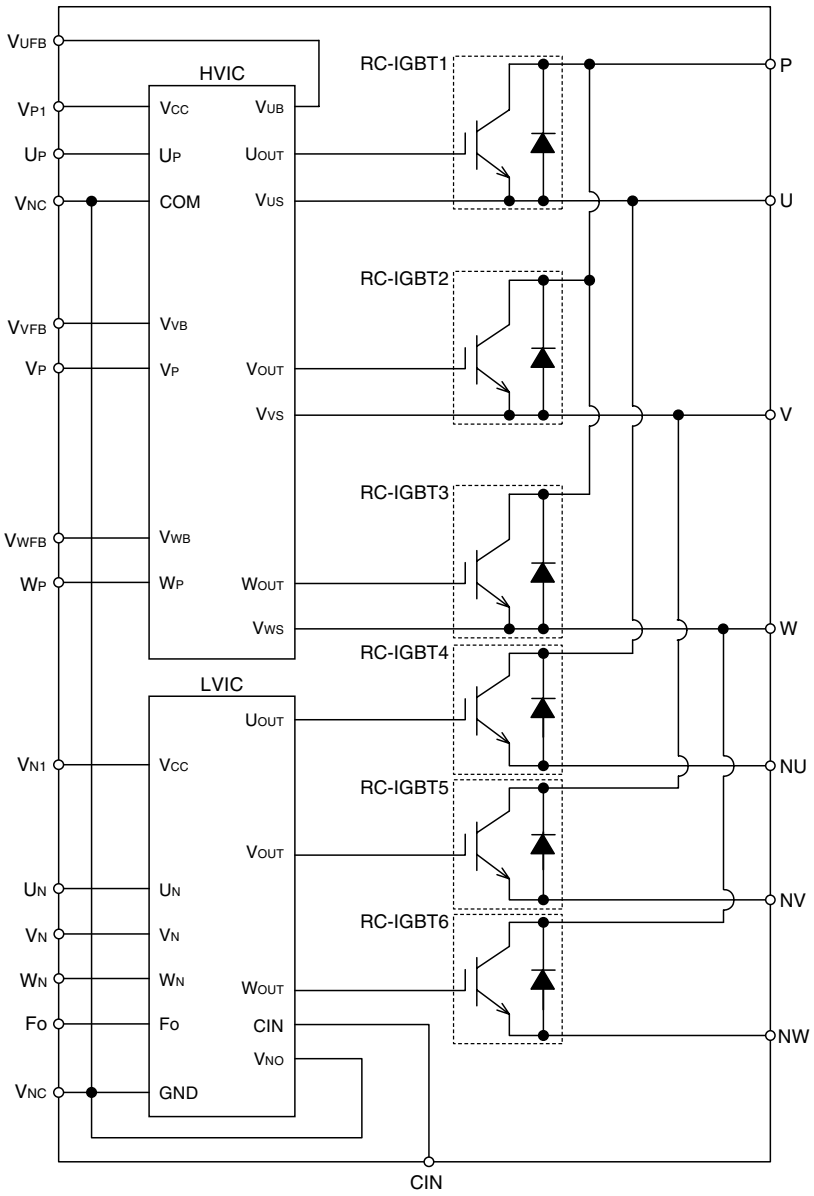
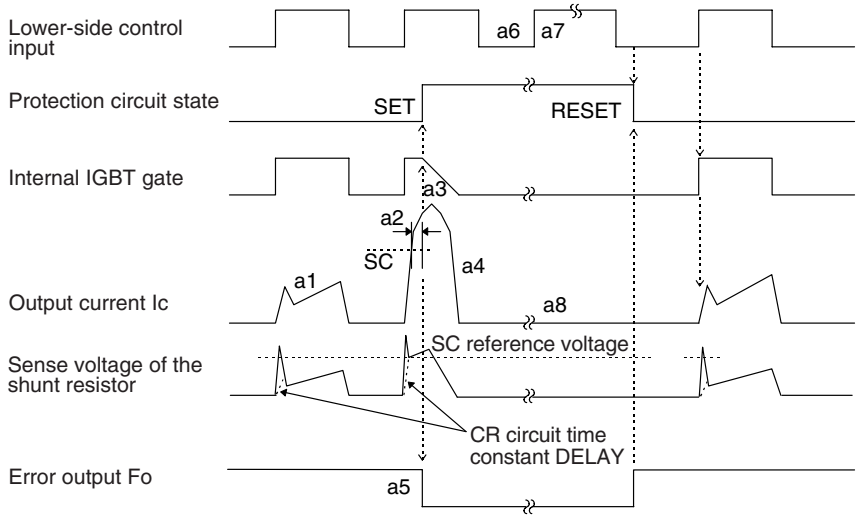


Fig. 3 TIMING CHART OF THE DIPIPM PROTECTIVE FUNCTIONS

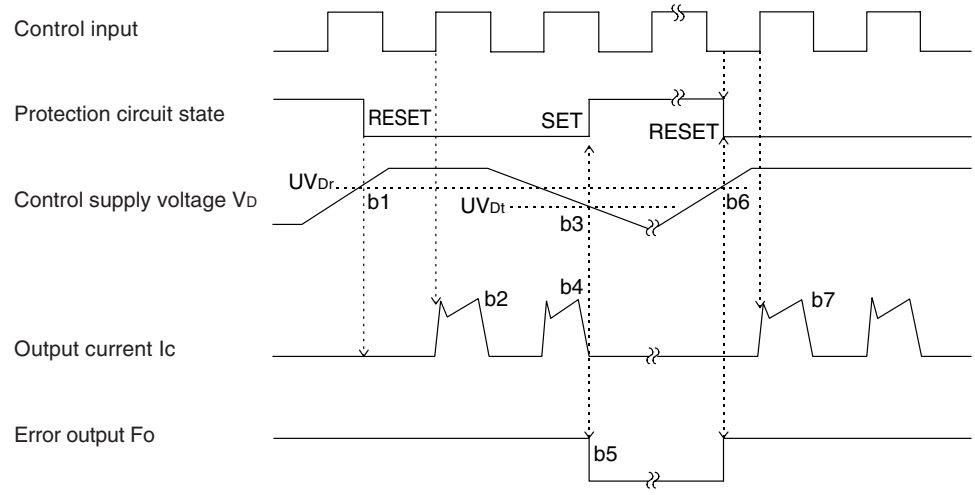
[A] Short-Circuit Protection (Lower-side only with the external shunt resistor and CR filter)

a1. Normal operation : IGBT ON and carrying current.
a2. Short circuit detection (SC trigger).
a3. IGBT gate hard interruption.
a4. IGBT turns OFF.
a5. FO outputs ($t_{FO(min)}$ = 20μs).
a6. Input "L" : IGBT OFF.
a7. Input "H" : IGBT ON.
a8. IGBT OFF in spite of input "H".



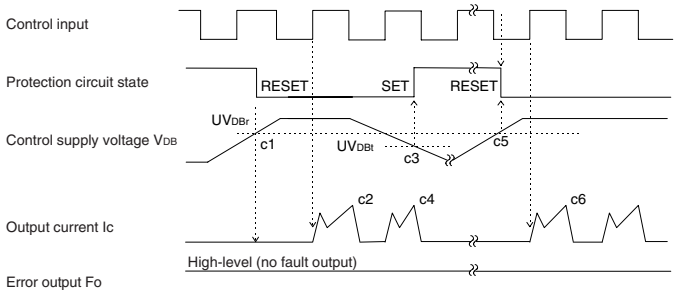
[B] Under-Voltage Protection (Lower-side, UV_D)

b1. Control supply voltage rising : After the voltage level reaches UV_{Dr}, the circuits start to operate when next input is applied.
b2. Normal operation : IGBT ON and carrying current.
b3. Under voltage trip (UV_{Dt}).
b4. IGBT OFF in spite of control input condition.
b5. FO outputs ($t_{FO} \geq 20\mu s$ and FO outputs continuously during UV period).
b6. Under voltage reset (UV_{Dr}).
b7. Normal operation : IGBT ON and carrying current.



[C] Under-Voltage Protection (Upper-side, UV_{DB})

c1. Control supply voltage rising : After the voltage level reaches UV_{DBr}, the circuits start to operate when next input is applied.
c2. Normal operation : IGBT ON and carrying current.
c3. Under voltage trip (UV_{DBt}).
c4. IGBT OFF in spite of control input signal level, but there is no F_O signal outputs.
c5. Under voltage reset (UV_{DBr}).
c6. Normal operation : IGBT ON and carrying current.



[D] Over Temperature Protection (Lower-side, OT)

d1. Normal operation : IGBT ON and carrying current.
d2. LVIC temperature exceeds over temperature trip level (OT_t).
d3. IGBT OFF in spite of control input condition.
d4. F_O outputs during over temperature period, however, the minimum pulse width is 20µs.
d5. LVIC temperature becomes under over temperature reset level.
d6. Circuits start to operate normally when next input is applied.

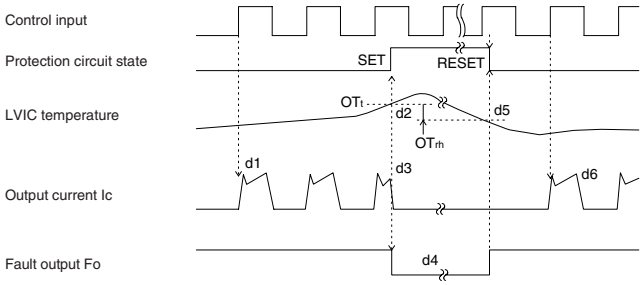
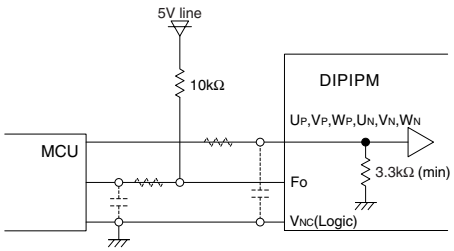


Fig. 4 RECOMMENDED MCU I/O INTERFACE CIRCUIT



Note : The setting of RC coupling at each input (parts shown dotted) depends on the PWM control scheme and the wiring impedance of the printed circuit board.
The DIPIPM input section integrates a 3.3kΩ (min) pull-down resistor. Therefore, when using an external filtering resistor, pay attention to the turn-on threshold voltage.

Fig. 5 WIRING CONNECTION OF SHUNT RESISTOR

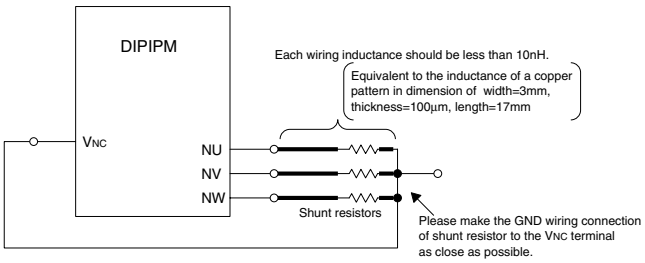
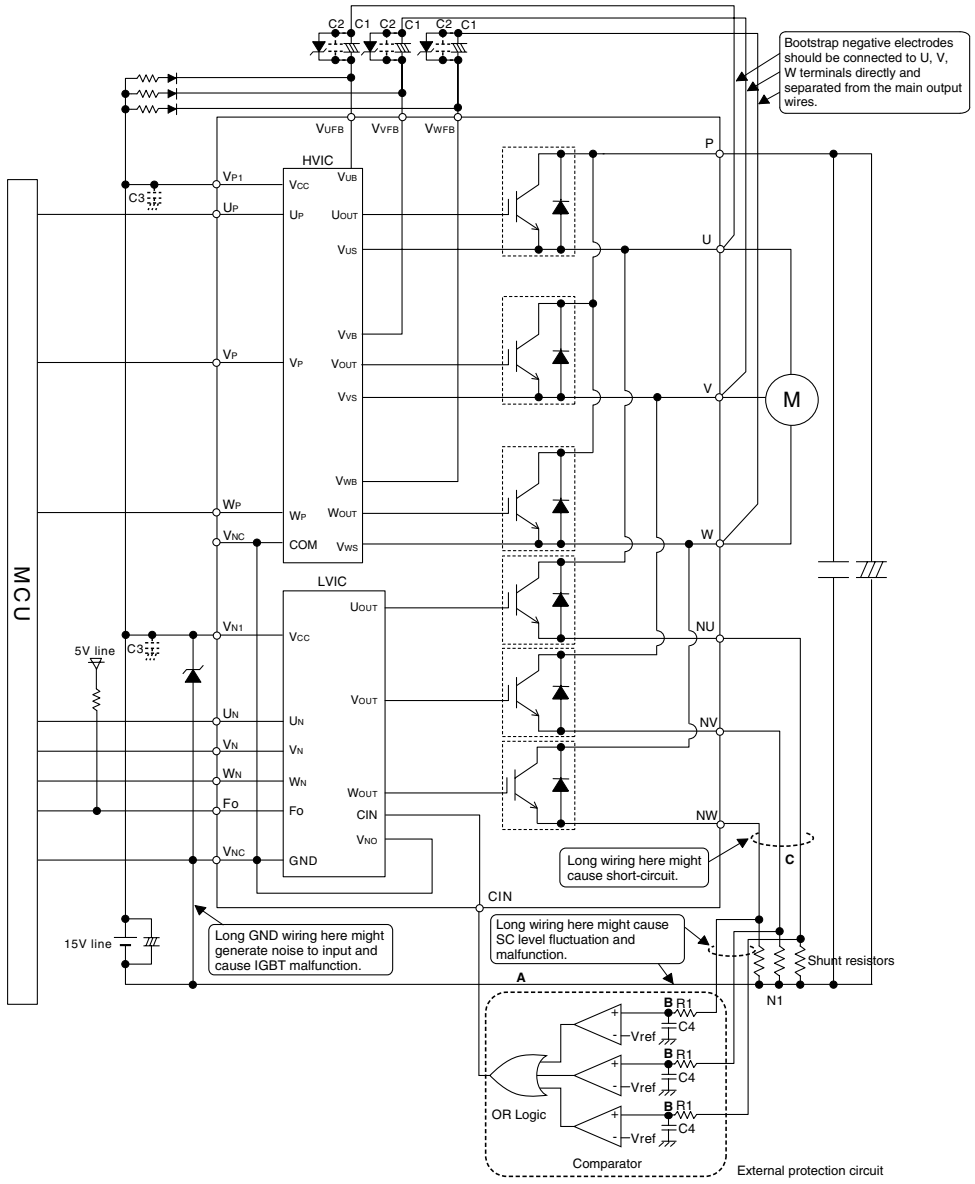


Fig. 6 AN EXAMPLE OF TYPICAL DIPIPM APPLICATION CIRCUIT

C1: Electrolytic capacitor with good temperature characteristics C2,C3: 0.22~2μF R-category ceramic capacitor for noise filtering



Note 1 : Input drive is High-Active type. There is a 3.3kΩ(min.) pull-down resistor integrated in the IC input circuit. To prevent malfunction, the wiring of each input should be as short as possible. When using RC coupling circuit, make sure the input signal level meet the turn-on and turn-off threshold voltage.

2 : Thanks to HVIC inside the module, direct coupling to MCU without any opto-coupler or transformer isolation is possible.

3 : FO output is open drain type. It should be pulled up to the positive side of a 5V power supply by a resistor of about 10kΩ.

4 : To prevent erroneous protection, the wiring of A, B, C should be as short as possible.

5 : The time constant R1C4 of the protection circuit should be selected in the range of 1.5-2μs. SC interrupting time might vary with the wiring pattern. Tight tolerance, temp-compensated type is recommended for R1, C4.

6 : All capacitors should be mounted as close to the terminals of the DIPIPM as possible. (C1: good temperature, frequency characteristic electrolytic type, and C2, C3: good temperature, frequency and DC bias characteristic ceramic type are recommended.)

7 : To prevent surge destruction, the wiring between the smoothing capacitor and the P, N1 terminals should be as short as possible. Generally a 0.1-0.22μF snubber between the P-N1 terminals is recommended.

8 : Two VNC terminals (9 & 16 pin) are connected inside DIPIPM, please connect either one to the 15V power supply GND outside and leave another one open.

9 : It is recommended to insert a Zener diode (24V/1W) between each pair of control supply terminals to prevent surge destruction.

10 : If control GND is connected to power GND by broad pattern, it may cause malfunction by power GND fluctuation. It is recommended to connect control GND and power GND at only a point.

11 : The reference voltage Vref of comparator should be set up the same rating of short circuit trip level (Vsc(ref): min.0.43V to max.0.53V).

12 : OR logic output high level should exceed the maximum short circuit trip level (Vsc(ref): max.0.53V).